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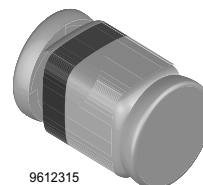
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Jameco Part Number 814215

Small Signal Fast Switching Diodes

Features

- Silicon Epitaxial Planar Diodes
- Saving space
- Hermetic sealed parts
- Fits onto SOD323 / SOT23 footprints
- Electrical data identical with the devices 1N4148 and 1N4448 respectively
- Micro Melf package
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



9612315

Applications

- Extreme fast switches

Mechanical Data

Case: MicroMELF Glass case

Weight: approx. 12 mg

Cathode Band Color: Black

Packaging Codes/Options:

TR3 / 10 k per 13" reel (8 mm tape), 10 k/box

TR / 2.5 k per 7" reel (8 mm tape), 12.5 k/box

Parts Table

Part	Type differentiation	Ordering code	Remarks
MCL4148	$V_{RRM} = 100\text{ V}$, V_F at $I_F 50\text{ mA} = 1\text{ V}$	MCL4148-TR3 or MCL4148-TR	Tape and Reel
MCL4448	$V_{RRM} = 100\text{ V}$, V_F at $I_F 100\text{ mA} = 1\text{ V}$	MCL4448-TR3 or MCL4448-TR	Tape and Reel

Absolute Maximum Ratings

$T_{amb} = 25\text{ °C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Repetitive peak reverse voltage		V_{RRM}	100	V
Reverse voltage		V_R	75	V
Peak forward surge current	$t_p = 1\text{ }\mu\text{s}$	I_{FSM}	2	A
Repetitive peak forward current		I_{FRM}	450	mA
Forward continuous current		I_F	200	mA
Average forward current	$V_R = 0$	I_{FAV}	150	mA
Power dissipation		P_{tot}	500	mW

Thermal Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Junction to ambient air	mounted on epoxy-glass hard tissue, Fig. 5, 35 μm copper clad, 0.9 mm^2 copper area per electrode	R_{thJA}	500	K/W
Junction temperature		T_j	175	$^{\circ}\text{C}$
Storage temperature range		T_{stg}	- 65 to + 175	$^{\circ}\text{C}$

Electrical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

Parameter	Test condition	Part	Symbol	Min	Typ.	Max	Unit
Forward voltage	$I_F = 5\text{ mA}$	MCL4448	V_F	620		720	mV
	$I_F = 50\text{ mA}$	MCL4148	V_F		860	1000	mV
	$I_F = 100\text{ mA}$	MCL4448	V_F		930	1000	mV
Reverse current	$V_R = 20\text{ V}$		I_R			25	nA
	$V_R = 20\text{ V}$, $T_j = 150\text{ }^{\circ}\text{C}$		I_R			50	μA
	$V_R = 75\text{ V}$		I_R			5	μA
Breakdown voltage	$I_R = 100\text{ }\mu\text{A}$, $t_p/T = 0.01$, $t_p = 0.3\text{ ms}$		$V_{(BR)}$	100			V
Diode capacitance	$V_R = 0$, $f = 1\text{ MHz}$, $V_{HF} = 50\text{ mV}$		C_D			4	pF
Rectification efficiency	$V_{HF} = 2\text{ V}$, $f = 100\text{ MHz}$		η_r	45			%
Reverse recovery time	$I_F = I_R = 10\text{ mA}$, $i_R = 1\text{ mA}$		t_{rr}			8	ns
	$I_F = 10\text{ mA}$, $V_R = 6\text{ V}$, $i_R = 0.1 \times I_R$, $R_L = 100\text{ }\Omega$		t_{rr}			4	ns

Typical Characteristics

$T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified

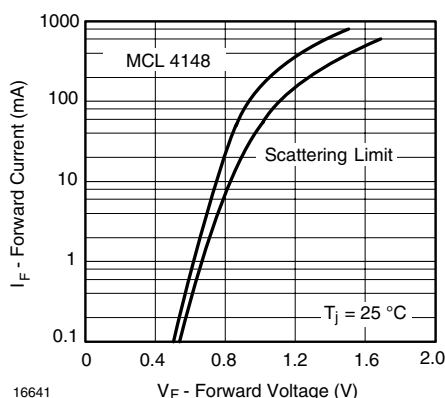


Figure 1. Forward Current vs. Forward Voltage

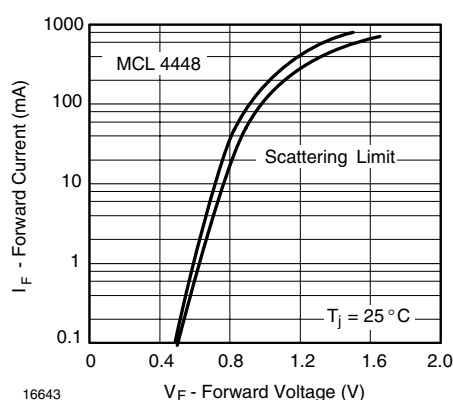


Figure 2. Forward Current vs. Forward Voltage

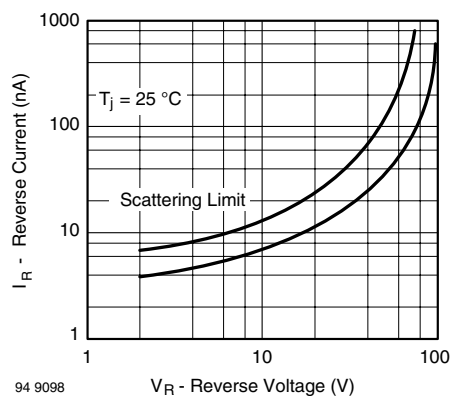


Figure 3. Reverse Current vs. Reverse Voltage

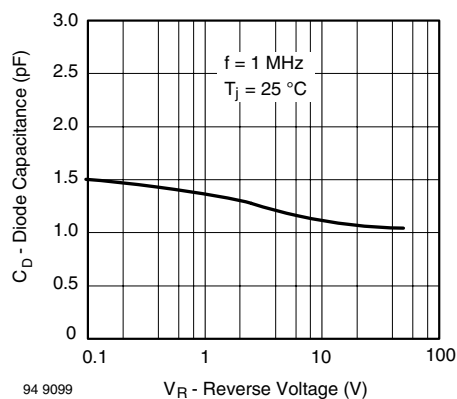


Figure 4. Diode Capacitance vs. Reverse Voltage

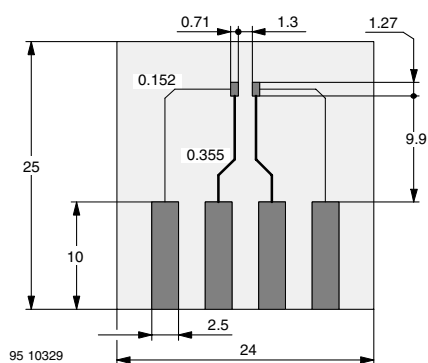
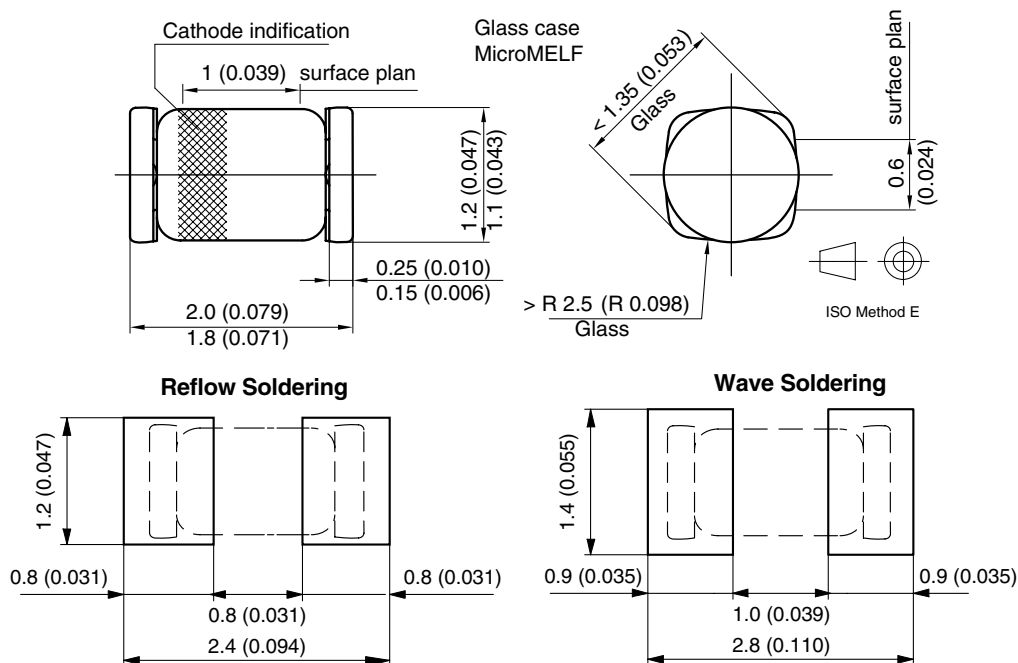


Figure 5. Board for R_{thJA} definition (in mm)

Package Dimensions in mm (Inches)



Document No.: 6.560-5007.01-4
Rev. 11, 07.Feb.2005
9612072



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design
and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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